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## H8/300L Series

#### Sorting (SORT)

#### Introduction

- 1. The software SORT sorts, on a byte-by-by basis, the data placed in the data memory into largest-to-smallest order (descending order).
- 2. The number of data items to be sorted can be specified within the range of 1 to 255.
- 3. Data to be sorted is represented as unsigned integers.

#### **Target Device**

H8/300L Series

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# RENESAS

### 1. Arguments

Description		Memory area	Data length (bytes)
Input	Number of data items to be sorted – 1	R0L	1
	Start address of the data to be sorted	R4	2
Output	_	—	_

#### 2. Changes to Internal Registers and Flags

R0	R1	R2	R3	R4	R5	R6	R7	
×	×	•	•	×	×	•	•	
1	U	Н	U	Ν	Z	V	С	
•	•	×	•	×	×	×	×	

•: No change

×: Undefined

‡: Result

#### 3. Specifications

Program memory (bytes)
34
Data memory (bytes)
0
Stack (bytes)
0
Clock cycle count
789482
Reentrant
Possible
Relocation
Possible
Interrupt
Possible

#### 4. Note

The clock cycle count (789482) in the specifications is for sorting 255 bytes of data into descending order.

# RENESAS

#### 5. Description

#### 5.1 Details of functions

- The following arguments are used with the software SORT: R0L: Sets the number of bytes of data to be sorted – 1 as an input argument. R4: Sets the start address of the data to be sorted (stored in RAM).
- 2. The following figure illustrates the execution of the software SORT. When the input arguments are set as shown in (1), the data is sorted in descending order as shown in (2).

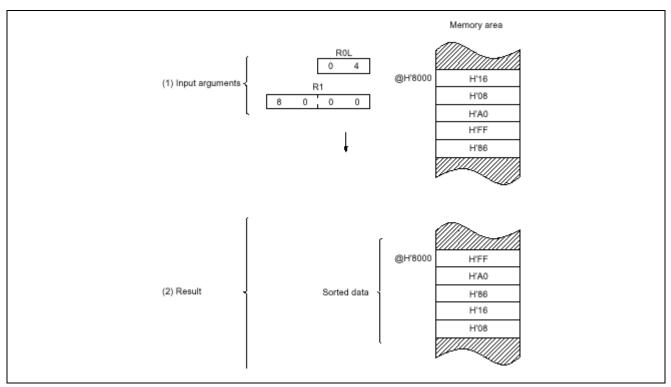


Figure 5.1 Example of Software SORT Execution

#### 5.2 Notes on usage

- 1. Do not set "0" in R0L; otherwise, the software SORT will not operate normally.
- 2. R0L must contain the number of bytes of data to be sorted 1.

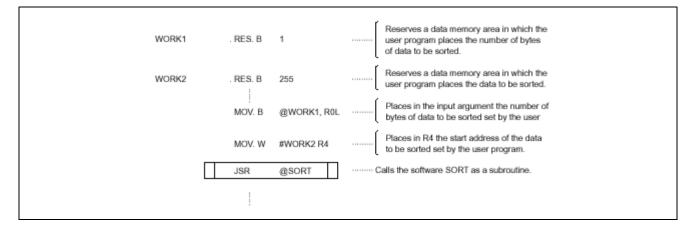
#### 5.3 Data memory

The software SORT uses no data memory.



#### 5.4 Example of use

Set the input arguments in registers and call the software SORT as a subroutine.



#### 5.5 Operation

1. The following figure shows an example where 3 items of data are sorted into largest-to-smallest order.

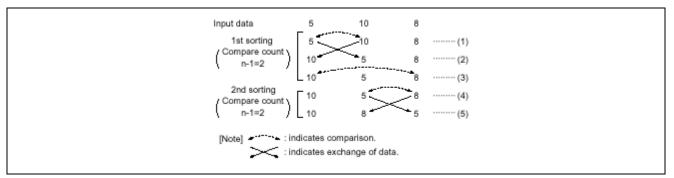
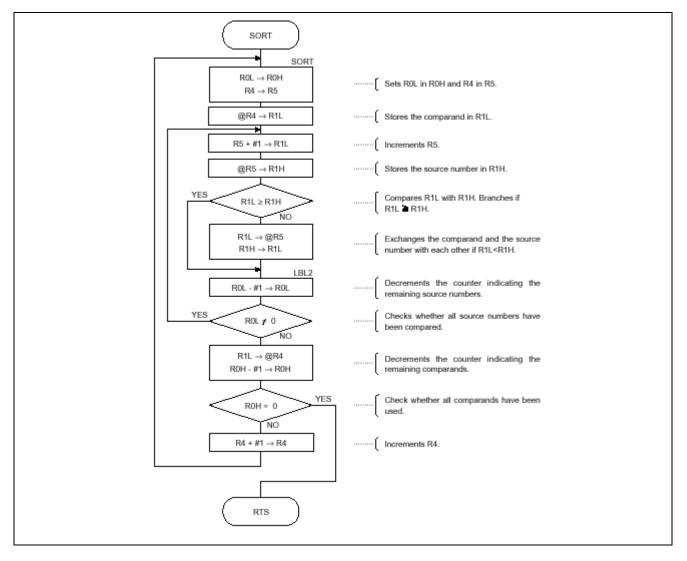


Figure 5.2 Example of Sorting

- A. The largest number of the 3 input data values is identified and placed at the far left ((1), (2) and (3) in the figure).
- B. Next, the larger of the second number from left and the last number is found and placed in the second position from left ((4) and (5) in the figure).
- 2. Processing by the program
  - A. R4 is used as the pointer for placing the largest number. R5 is used as the pointer to the address of the memory area containing the number to be compared.
  - B. The comparand is placed in R1L.
  - C. The number to be compared is placed in R1H.
  - D. R1H is compared with R1L. If the number to be compared is greater than the comparand (R1H > R1L), the two numbers are exchanged.
  - E. Steps C and D is repeated until the counter R0L, indicating the number of remaining data items to be compared, reaches "0".
  - F. When R0L reaches "0", the data stored in @R4 is the largest of the data items that have been compared in the current round of comparisons.
  - G. The R0H, a counter that indicates how many data items remain for use as comparands, is decremented.



#### 6. Flowchart





#### 7. Program List

\*\*\* H8/300 ASSEMBLER VER 1.0B \*\* 08/18/92 10:26:21

PROGRAM	NAME =						
1				;*****	******	*****	***************************************
2				;*			
3				;*	00 - NZ	AME	:SORTING (SORT)
4				;*			
5				;*****	******	******	******************
6				;*			
7				;*	ENTRY		:ROL (BYTE NUMBER)
8				; *			R4 (START ADDRESS OF DATA)
9				; *			
10				; *	RETURN		:NOTHING
11				; *			
12				;****	******	*****	*****
13				;			
14	SORT_cod C	0000			.SECTIO	DN	SORT_code,CODE,ALIGN=2
15					.EXPORT	2	SORT
16				;			
17	SORT_cod C		0000000	SORT	.EQU \$		;Entry point
18	SORT_cod C	0000	0C80		MOV.B	ROL,ROH	;Set data counter
19	SORT_cod C	0002	0D45		MOV.W	R4,R5	;R4 -> R5
20	SORT_cod C	0004	6849		MOV.B	@R4,R1L	;@R4 -> data1
21	SORT_cod C	0006		LBL1			
22	SORT_cod C	0006	0B05		ADDS.W	#1,R5	;Increment address pointer1 (R5++)
23	SORT_cod C	0008	6851		MOV.B	@R5,R1H	;@R5 -> data2
24	SORT_cod C	A000	1C19		CMP.B	R1H,R1L	
25	SORT_cod C	000C	4404		BHS	LBL2	;Branch if $C = 0$
26	SORT_cod C	000E	68D9		MOV.B	R1L,@R5	;Store datal @R5
27	SORT_cod C	0010	0C19		MOV.B	R1H,R1L	;data2 -> data1
28	SORT_cod C	0012		LBL2			
29	SORT_cod C	0012	1A00		DEC.B	ROH	;Decrement data counter
30	SORT_cod C	0014	46F0		BNE	LBL1	;Branch if Z=0
31	SORT_cod C	0016	68C9		MOV.B	R1L,@R4	;datal -> @R4
32	SORT_cod C	0018	1A08		DEC.B	ROL	;Decrement byte number
33	SORT_cod C	001A	4704		BEQ	EXIT	;Branch Z=0
34	SORT_cod C	001C	0804		ADDS.W	#1,R4	;Increment address pointer2 (R4++)
35	SORT_cod C	001E	40E0		BRA	SORT	;Branch always
36	SORT_cod C	0020		EXIT			
37	SORT_cod C	0020	5470		RTS		
38				;			
39					.END		
****T01	TAL ERRORS 0						

\*\*\*\*\*TOTAL WARNINGS 0



#### **Revision Record**

		Descripti	ion	
lev.	Date	Page	Summary	
.00	Sep.18.03	_	First edition issued	



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